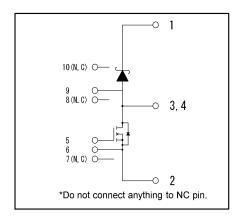
Application

- · Motor drive
- · Converter
- · Photovoltaics, wind power generation.

Features

- 1) Low surge, low switching loss.
- 2) High-speed switching possible.
- 3) Reduced temperature dependence.

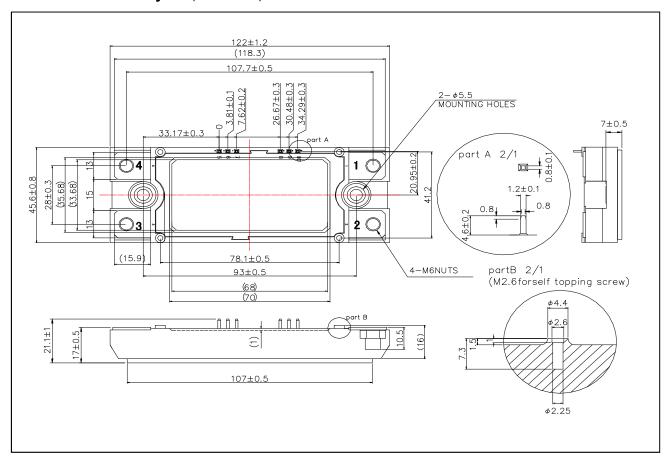
●Circuit diagram



Construction

This product is a chopper module consisting of SiC-DMOSFET and SiC-SBD from ROHM.

●Dimensions & Pin layout (Unit : mm)

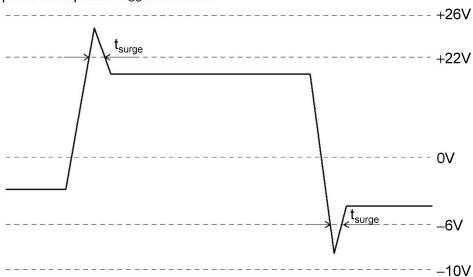


●Absolute maximum ratings (T_j = 25°C)

Parameter	Symbol	Conditions	Limit	Unit	
Drain-source voltage	V_{DSS}	G-S short	1200		
Repetitive reverse voltage	V_{DSS}	Clamp diode	1200		
Gate-source voltage(+)	V_{GSS}	D-S short	22] v	
Gate-source voltage(-)	V GSS	D-3 SHOIL	- 6		
G - S Voltage (t _{surge} <300nsec)	V_{GSS_surge}	D-S short	-10 to 26		
Drain current * ¹	I _D	DC (T _c =60°C)	134		
	I _{DRM}	Pulse (T _c =60°C) 1ms * ²	240]	
	I _{DRM}	Pulse (T _c =60°C) 10us * ²	360	1	
Source current *1	I _S	DC (T _c =60°C) V _{GS} =18V 134		1	
	I _{SRM}	Pulse (Tc=60°C) 1ms V _{GS} =18V * ²	240	A	
	I _{SRM}	Pulse (Tc=60°C) 10us V _{GS} =18V * ²	360]	
Forward curent (clamp diode) *1	I _F	DC (T _c =60°C) V _{GS} =18V	134	1	
	I _{FRM}	Pulse (Tc=60°C) 1ms V _{GS} =18V * ²	240		
	I _{FRM}	Pulse (Tc=60°C) 10us V _{GS} =18V * ²	360		
Total power disspation *4	Ptot	T _c =25°C	935	W	
Max Junction Temperature	T _{jmax}		175		
Junction temperature	T_jop		-40 to150	°C	
Storage temperature	T _{stg}		-40 to125		
Isolation voltage	Visol	Terminals to baseplate, f=60Hz AC 1min.	2500	Vrms	
Mounting torque		Main Terminals : M6 screw	4.5	NI ma	
Mounting torque	_	Mounting to heat shink : M5 screw	3.5	N·m	

^(*1) Case temperature (T_c) is defined on the surface of base plate just under the chips.

Example of acceptable V_{GS} waveform



^(*2) Repetition rate should be kept within the range where temperature rise if die should not exceed $T_{j \text{ max.}}$

^(*3) T_j is less than 175°C

●Electrical characteristics (T_i=25°C)

Parameter	Symbol	Conditions		Min.	Тур.	Max.	Unit
On-state static Drain-Source Voltage	$V_{DS(on)}$	I _D 120A, V _{GS} =18V	T _j =25°C	-	2.1	3.2	V
			T _j =125°C	-	3.1	-	
			T _j =150°C	-	3.4	5.2	
Drain cutoff current	I _{DSS}	V _{DS} =1200V, V _{GS} =0V		-	-	10	μΑ
Forwad Voltage	V _F	I _F =120A	T _j =25°C	-	1.7	2.1	V
			T _j =125°C		2.2	-	
			T _j =150°C	-	2.4	3.2	
Reverse curent	I _{RRM}	Clamp diode	-	-	2	mA	
Gate-source threshold voltage	$V_{GS(th)}$	V _{DS} =10V, I _D =22mA	1.6	-	4	V	
Gate-source leakage current	I _{GSS}	V _{GS} =22V, V _{DS} =0V		-	-	0.5	μА
		V_{GS} = -6V, V_{DS} =0V	-0.5	-	-		
Switching characteristics	t _{d(on)}	V _{GS(on)} =18V, V _{GS(off)} =0V		-	30	-	ns
	t _r	V _{DS} =600V	-	40	-		
	t _{rr}	I _D =120A	-	20	-		
	t _{d(off)}	R_G =2.2 Ω	-	165	-		
	t _f	inductive load	-	45	-		
Input capacitance	Ciss	V _{DS} =10V, V _{GS} =0V, 1M	-	14	-	nF	
Gate Registance	R _{Gint}	T _j =25°C		-	1.8	-	Ω
Stray Inductance	Ls			25	-	nΗ	
Creepage Distance	-	Terminal to heat sink			12.5	-	mm
		Terminal to terminal			20	-	mm
Clearance Distance	-	Terminal to heat sink			10.5	-	mm
		Terminal to terminal			14	-	mm
Junction-to-case thermal resistance	R _{th} (j-c)	DMOS (1/2 module) *5		-	-	0.16	°C/W
		SBD (1/2 module) *5		-	-	0.21	
Case-to-heat sink	R _{th} (c-f)	Case to heat sink, per 1 module,		-	0.035	-	
Thermal resistance		Thermal grease appied *6					

- (*4) In order to prevent self turn-on, it is recommended to apply negative gate bias.
- (*5) Measurement of Tc is to be done at the point just under the chip.
- (*6) Typical value is measured by using thermally conductive grease of λ=0.9W/(m K).
- (*7) SiC devices have lower short cuicuit withstand capability due to high current density. Please be advised to pay careful attention to short cuicuit accident and try to adjust protection time to shutdown them as short as possible.
- (*8) If the Product is used beyond absolute maximum ratings defined in the Specifications, as its internal structure may be dameged, please replace such Product with a new one.

<Wavelength for Switching Test>

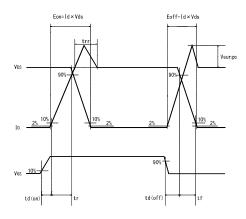
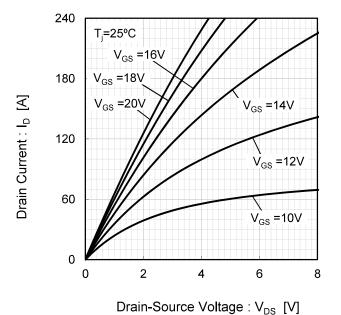


Fig.1 Typical Output Characteristics [T_i =25°C] Fig.2 Drain-Source Voltage vs. Drain Current



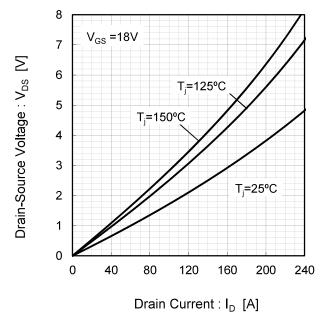


Fig.3 Drain-Source Voltage vs. Gate-Source Voltage [T_i=25°C] 6 T_i=25°C 5 Drain-Source Voltage: V_{DS} [V] 4 3 I_D=120A I_D=100A 2 I_D=60A 1 $I_D = 20A$ 0 12 14 16 18 20 22 24 Gate-Source Voltage : V_{GS} [V]

Fig.4 Static Drain - Source On-State Resistance vs. Junction Temperature

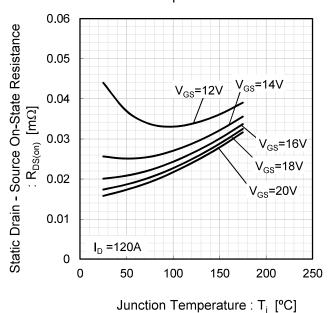


Fig.5 Forward characteristic of Diode

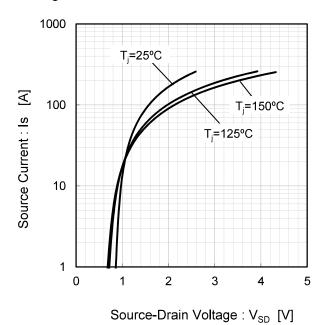
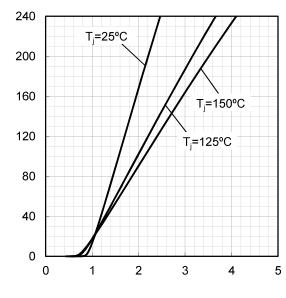


Fig.6 Forward characteristic of Diode



Source-Drain Voltage : V_{SD} [V]

Fig.7 Drain Current vs. Gate-Source Voltage

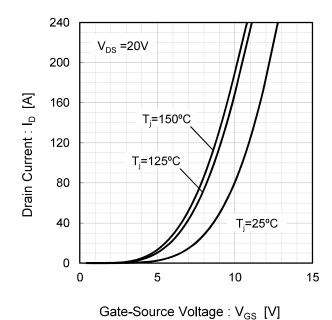
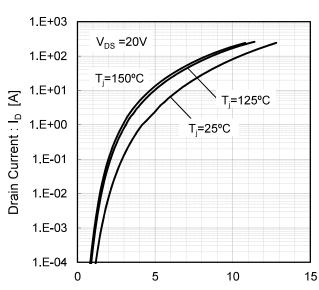


Fig.8 Drain Current vs. Gate-Source Voltage



Gate-Source Voltage : V_{GS} [V]

⊴

Source Current : Is

Fig.9 Switching Characteristics [T_i=25°C]

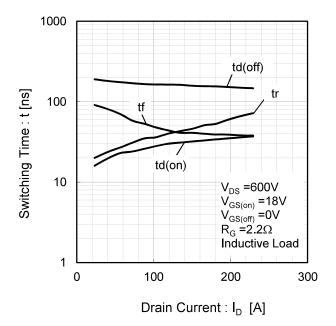


Fig.10 Switching Characteristics [T_i=125°C]

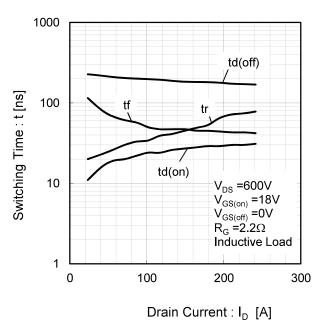


Fig.11 Switching Characteristics [T_i=150°C]

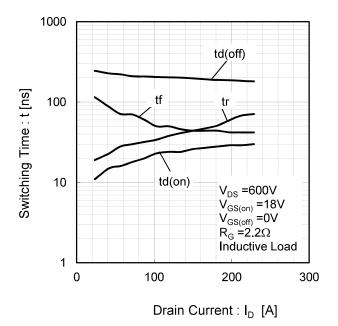
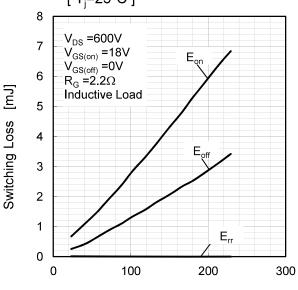


Fig.12 Switching Loss vs. Drain Current [T_i=25°C]



Drain Current : I_D [A]

ROHM

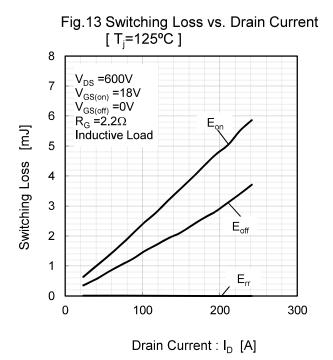
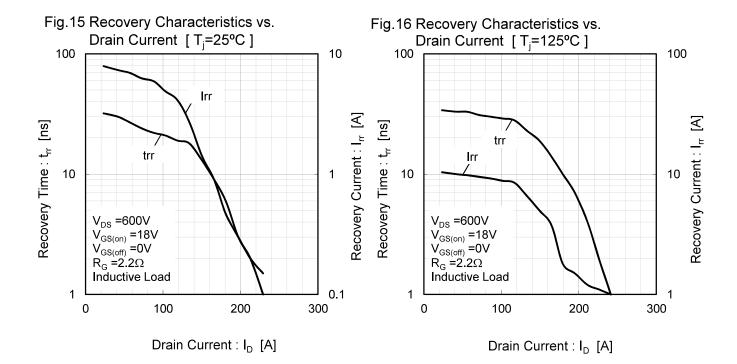


Fig.14 Switching Loss vs. Drain Current [T_i=150°C] 8 V_{DS} =600V 7 $V_{GS(on)} = 18V$ $V_{GS(off)} = 0V$ $R_G = 2.2\Omega$ 6 Inductive Load 5 4 3 2 $\mathsf{E}_{\mathsf{off}}$ 1 E_{rr} 0 100 200 300 Drain Current : I_D [A]



<u>__</u>

Switching Loss

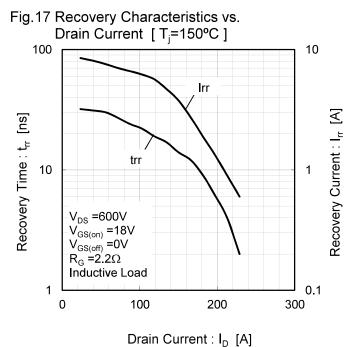
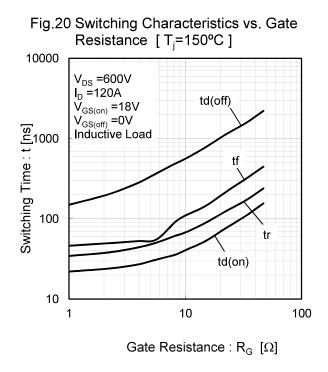


Fig. 18 Switching Characteristics vs. Gate Resistance [T_j =25°C] $V_{DS} = 600V$ $I_D = 120A$ $V_{GS(on)} = 18V$ $V_{GS(off)} = 0V$ Inductive Load 100 10 10 10

Gate Resistance : R_G [Ω]

Fig. 19 Switching Characteristics vs. Gate Resistance [T_j =125°C] $V_{DS} = 600V$ $I_{D} = 120A$ $V_{GS(on)} = 18V$ $V_{GS(off)} = 0V$ Inductive Load 100 $Gate Resistance : R_G [<math>\Omega$]



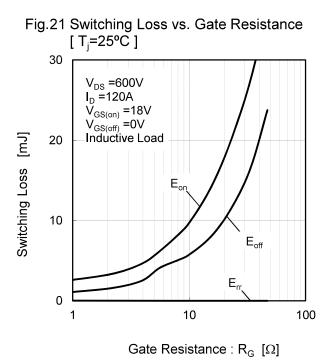
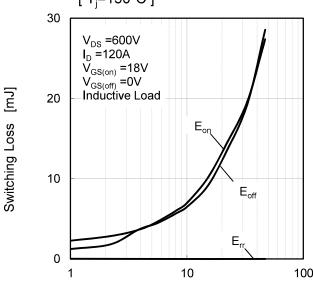


Fig.22 Switching Loss vs. Gate Resistance [T_i=125°C] 30 V_{DS} =600V I_D =120A $V_{GS(on)} = 18V$ $V_{GS(off)} = 0V$ Inductive Load 20 10 Err 0 10 100

Switching Loss

Fig.23 Switching Loss vs. Gate Resistance [T_i=150°C] 30



Gate Resistance : R_G [Ω]

Fig.24 Typical Capacitance vs. Drain-Source Voltage

Gate Resistance : R_G [Ω]

